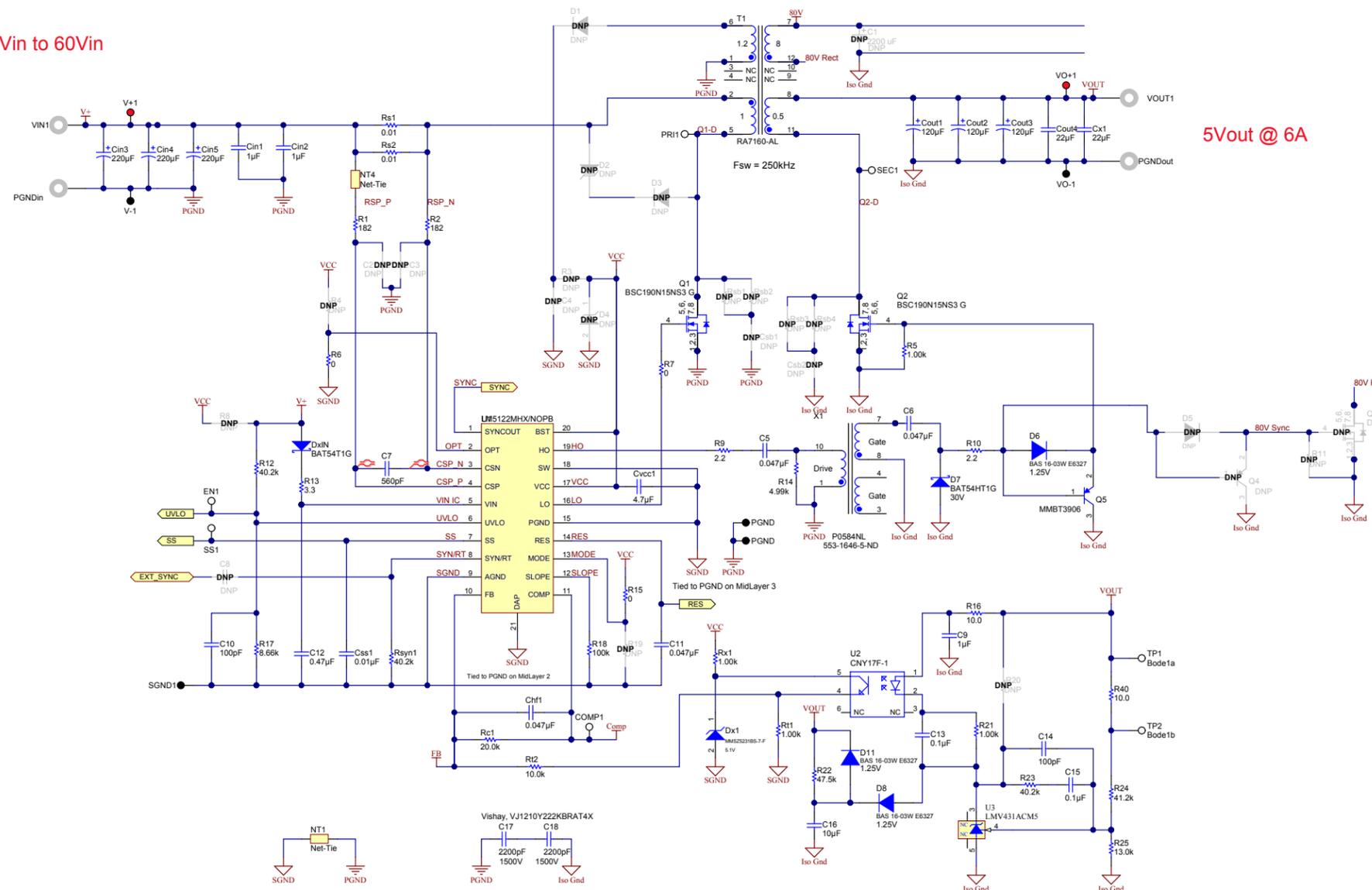


Input Voltage = 9Vin to 60Vin



5Vout @ 6A

\*NOTE: Any component that is not on the schematic is omitted from the design and not populated on the PCB (or disconnected).

H1 NY PMS 440 0025 PH H2 NY PMS 440 0025 PH H3 NY PMS 440 0025 PH H4 NY PMS 440 0025 PH

H5 1902C H6 1902C H7 1902C H8 1902C

FID1 FID2 FID3

PCB Number: PMP10506  
PCB Rev: E1

PCB  
LOGO  
Texas Instruments

LOGO2  
  
DANGER HIGH VOLTAGE

LOGO3  
  
CAUTION HOT SURFACE

| Label Table |            |
|-------------|------------|
| Variant     | Label Text |
| 001         |            |
|             |            |
|             |            |
|             |            |
|             |            |
|             |            |
|             |            |

ZZ2  
**Assembly Note**  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
**Assembly Note**  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
**Assembly Note**  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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|  |   |   |   |
|--|---|---|---|
| Orderable: N/A   | Designed for: Public Release                              | Mod. Date: 4/29/2015  |  |
| TID #: PMP10506  | Project Title: 30W Synchronous Isolated Flyback Converter |   |   |
| Number: PMP10506   | Rev: A5   | Sheet Title: Hardware   |   |
| SVN Rev: Version control disabled  | Assembly Variant: 001                                     | Sheet: 2 of 2   |   |
| Drawn By: Engineer: Hrag Kasparian   | File: PMP10506_TID_Hardware.SchDoc                        | Size: B   |   |
| Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a> |   | <a href="http://www.ti.com">http://www.ti.com</a><br>© Texas Instruments 2015 |   |

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